SDAS226A - DECEMBER 1982 - REVISED JANUARY 1995

- Local Bus-Latch Capability
- Choice of True or Inverting Logic
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (N) 300-mil DIPs

DEVICE	OUTPUT	LOGIC
SN74ALS620A	3 state	Inverting
SN74ALS621A	Open collector	True
SN74ALS623A, SN74AS623	3 state	True

(TOP VIEW) OEAB [20 🛭 V_{CC} 19 OEBA А1 [2 A2 [18 B1 3 A3 [B2 17 A4 🛮 5 16**∏** B3 A5 [6 15 □ B4 **∏** B5 A6 ∏ 7 14 A7 **∏** 8 13**∏** B6 A8 [9 12 ∏ B7 GND [] 10 11 **∏** B8

DW OR N PACKAGE

description

These octal bus transceivers are designed for asynchronous two-way communication between data buses. The control-function implementation allows for maximum flexibility in timing.

These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending upon the logic levels at the output-enable (OEAB and OEBA) inputs.

The output-enable inputs disable the device so that the buses are effectively isolated. The dual-enable configuration gives the transceivers the capability to store data by simultaneously enabling OEAB and OEBA. Each output reinforces its input in this transceiver configuration. When both OEAB and OEBA are enabled and all other data sources to the two sets of bus lines are in the high-impedance state, both sets of bus lines (16 total) remain at their last states. The 8-bit codes appearing on the two sets of buses are identical for the SN74ALS621A, SN74ALS623A, and SN74AS623 or complementary for the SN74ALS620A.

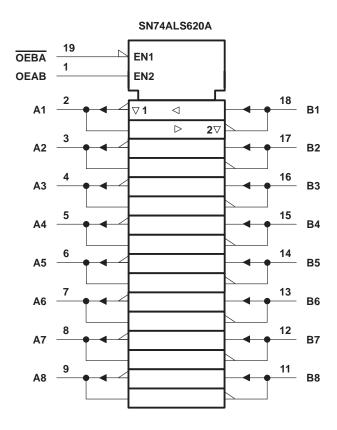
The -1 versions of the SN74ALS620A and SN74ALS621A are identical to the standard versions, except that the recommended maximum I_{OI} is increased to 48 mA in the -1 versions.

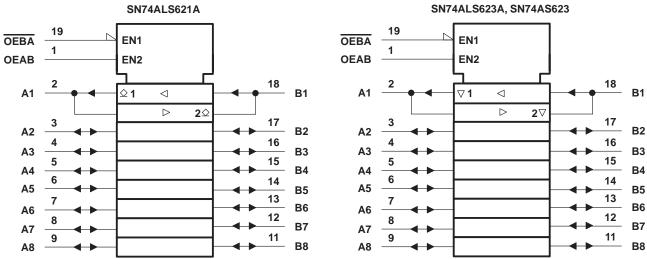
The SN74ALS620A, SN74ALS621A, SN74ALS623A, and SN74AS623 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE

INPUTS		OPERATION		
OEBA OEAB		SN74ALS620A	SN74ALS621A SN74ALS623A SN74AS623	
L	L	B data to A bus	B data to A bus	
Н	Н	A data to B bus	A data to B bus	
Н	L	Isolation	Isolation	
L	Н	B data to A bus, A data to B bus	B data to A bus, A data to B bus	

logic symbols†

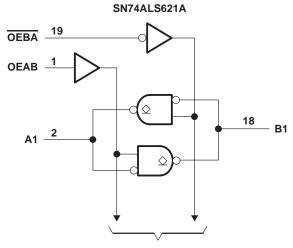




[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagrams (positive logic)

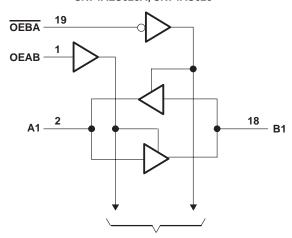
SN74ALS620A OEBA 19 OEAB 1 18 B1



To Seven Other Transceivers

To Seven Other Transceivers

SN74ALS623A, SN74AS623



To Seven Other Transceivers

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	7 V
Input voltage, V _I : All inputs	7 V
I/O ports	5.5 V
Operating free-air temperature range, T _A : SN74ALS620A, SN74ALS623A	0°C to 70°C
Storage temperature range6	5°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

SDAS226A - DECEMBER 1982 - REVISED JANUARY 1995

recommended operating conditions

		SN74ALS620A SN74ALS623A			UNIT
		MIN	NOM	MAX	
Vcc	Supply voltage	4.5	5	5.5	V
VIH	High-level input voltage	2			V
VIL	Low-level input voltage			0.8	V
IOH	High-level output current			-15	mA
loL	Low-level output current			24	mA
T _A	Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN74ALS620A SN74ALS623A		-	UNIT
				MIN	TYP [†]	MAX	
VIK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	<u>)</u>		
Vон	VOH	V _{CC} = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.2		V
		∨CC = 4.5 ∨	$I_{OH} = -15 \text{ mA}$	2			
\/a:		V22 - 45 V	I _{OL} = 12 mA		0.25	0.4	V
VOL		V _{CC} = 4.5 V	$I_{OL} = 24 \text{ mA}^{\ddagger}$		0.35	0.5	\ \ \
ı.	Control inputs	V _{CC} = 5.5 V	V _I = 7 V			0.1	mA
t ₁	A or B ports	vCC = 9.9 v	V _I = 5.5 V			0.1	mA
I	Control inputs		\/. 0.7.\/			20	
lН	A or B ports§	$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V			20	μΑ
l	Control inputs	V 55V	\/. 0.4\/			-0.1	mA
IIL	A or B ports§	$V_{CC} = 5.5 \text{ V},$	V _I = 0.4 V			-0.1	mA
Io¶		V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	mA
			Outputs high		24	34	
	SN74ALS620A	$V_{CC} = 5.5 V$	Outputs low		31	44	
			Outputs disabled		33	47	mA
Icc			Outputs high		32	43	IIIA
	SN74ALS623A	$V_{CC} = 5.5 V$	Outputs low		39	50	
			Outputs disabled		42	55	1

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

 $[\]ddagger$ Applies only to the -1 version and only if VCC is between 4.75 V and 5.25 V

 $[\]S$ For I/O ports, the parameters $I_{\hbox{\scriptsize IH}}$ and $I_{\hbox{\scriptsize IL}}$ include the off-state output current.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, los.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	112 = 000;		,	UNIT	
			SN74AL	S620A	SN74AL	S623A	
			MIN	MAX	MIN	MAX	
t _{PLH}	А		2	10	2	13	ns
^t PHL	A	В	2	10	3	11	115
t _{PLH}	В	A	2	10	2	13	ns
^t PHL		А	2	10	3	11	115
^t PZH	OEBA	^	3	17	5	22	ns
t _{PZL}	OEBA	А	5	25	5	22	115
^t PHZ	OEBA	٨	2	12	2	16	ns
^t PLZ	OEBA	А	3	18	2	19	115
^t PZH	OFAR	В	3	18	5	22	ns
^t PZL	OEAB	В	5	25	5	22	115
^t PHZ	OEAB	В	2	12	2	16	ns
^t PLZ	OLAB	ט	3	18	2	19	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}		 7 V
Input voltage, V _I : All inputs and I/O ports		 7 V
Operating free-air temperature range, T _A :	SN74ALS621A .	 0°C to 70°C
Storage temperature range		 -65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN74ALS621A		UNIT	
		MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			V
V _{IL}	Low-level input voltage			0.8	V
Vон	High-level output voltage			5.5	V
la.	Low lovel output ourrant			24	mA
IOL	Low-level output current			48§	mA
TA	Operating free-air temperature	0		70	°C

 $[\]S$ Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V



SDAS226A - DECEMBER 1982 - REVISED JANUARY 1995

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CO	NUDITIONS	SN	74ALS62	1A	UNIT
	PARAMETER	TEST CONDITIONS		MIN TYPT		MAX	UNII
٧ıĸ		$V_{CC} = 4.5 V,$	$I_1 = -18 \text{ mA}$			-1.5	V
IOH		$V_{CC} = 4.5 V,$	V _{OH} = 5.5 V			0.1	mA
\/		V45V	I _{OL} = 24 mA		0.35	0.5	V
VOL		VCC = 4.5 V	$V_{CC} = 4.5 \text{ V}$ $I_{OL} = 48 \text{ mA}^{\ddagger}$		0.35	0.5	V
ī	Control inputs	V-2 - 5 5 V	V _I = 7 V			0.1	mA
'1	A or B ports	V _{CC} = 5.5 V	V _I = 5.5 V			0.1	mA
	Control inputs	V 55V	\/. 27\/			20	
ΊΗ	A or B ports§	$V_{CC} = 5.5 V$,	$V_{I} = 2.7 \text{ V}$			20	μΑ
Ίμ	Control inputs	V 55V				-0.1	A
	A or B ports§	$V_{CC} = 5.5 V$	$V_{I} = 0.4 \text{ V}$			-0.1	mA
1		V	Outputs high		29	40	mA
Icc		V _{CC} = 5.5 V	Outputs low		35	48	IIIA

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ $C_L = 50 \text{ pF},$ $R_L = 680 \Omega,$ $T_A = \text{MIN to MAX}$ SN74ALS621A		UNIT
			MIN	MAX	
t _{PLH}	А	В	10	33	ns
t _{PHL}		В	5	20	113
t _{PLH}	В		10	33	ns
^t PHL	В	A	5	20	115
^t PLH	<u> </u>		10	39	
^t PHL	OEBA	A	12	35	ns
t _{PLH}	OEAB	В	10	39	20
^t PHL	OEAB	В	12	35	ns

[¶] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V

[§] For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

SDAS226A - DECEMBER 1982 - REVISED JANUARY 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	7 V
Input voltage, V _I : All inputs	7 V
I/O ports	5.5 V
Operating free-air temperature range, TA: SN74AS623	0°C to 70°C
Storage temperature range	-65°C to 150°C

recommended operating conditions

		SN74AS623		3	UNIT
		MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			V
V _{IL}	Low-level input voltage			0.8	V
IOH	High-level output current			-15	mA
lOL	Low-level output current			64	mA
TA	Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER		TEGT 00ND	SN74AS623				
	PARAMETER	TEST COND	MIN	TYP [‡]	MAX	UNIT	
۷ıK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2	V
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	I _{OH} = −2 mA	V _{CC} -2			
Vон		V 45V	$I_{OH} = -3 \text{ mA}$	2.4	3.2		V
		$V_{CC} = 4.5 \text{ V}$	$I_{OH} = -15 \text{ mA}$	2			
VOL		$V_{CC} = 4.5 V,$	$I_{OL} = 64 \text{ mA}$		0.35	0.55	V
1.	Control inputs	V F5V	V _I = 7 V			0.1	mA
'1	A or B ports	$V_{CC} = 5.5 V$	V _I = 5.5 V			0.1	
1	Control inputs	V	\/. 07\/			20	^
lН	A or B ports§	$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V			70	μΑ
l	Control inputs	V	\/. 0.4\/			-0.5	A
IIL	A or B ports§	$V_{CC} = 5.5 \text{ V},$	V _I = 0.4 V			-0.75	mA
IoI		$V_{CC} = 5.5 V,$	V _O = 2.25 V	-30		-150	mA
			Outputs high		57	93	
ICC		$V_{CC} = 5.5 V$	Outputs low		16	189	mA
			Outputs disabled		71	116	

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[§] For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

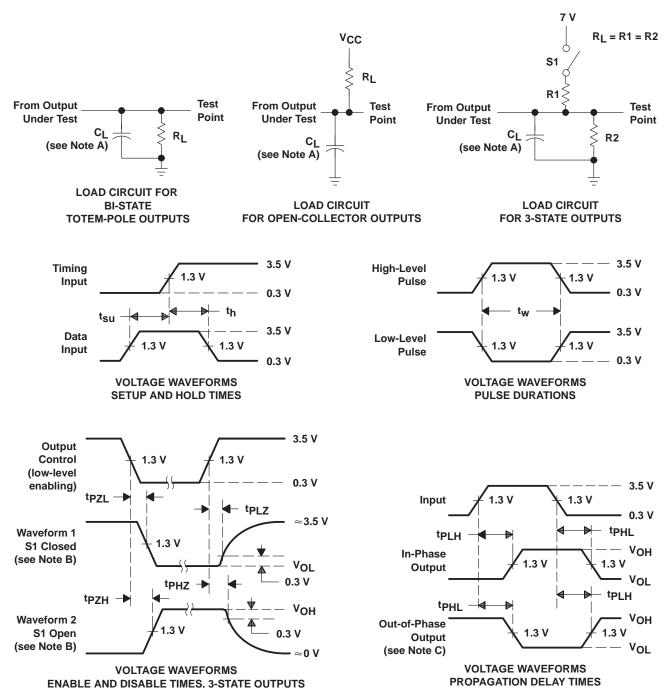
SDAS226A - DECEMBER 1982 - REVISED JANUARY 1995

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5$ $^{\circ}$	UNIT	
			MIN	MAX	
t _{PLH}	A		1	9	ns
^t PHL	A	В	1	8	
t _{PLH}	В	•	1	9	ns
^t PHL	ם	А	1	8.5	
^t PZH	OEBA	•	2	11	ns
^t PZL	OEBA	А	2	10	
^t PHZ	 OEBA		1	7.5	
^t PLZ	OEBA	А	1	11.5	ns
^t PZH	OFAR		2	11.5	ns
tPZL	OEAB	В	2	11	115
^t PHZ	OEAB	В	1	7	ns
^t PLZ	OLAD	ט	1	9	115

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_f = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







om 4-Jun-2007

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Packag Qty	e Eco Plan ⁽²⁾	Lead/Ball Finisl	n MSL Peak Temp ⁽³⁾
SN74ALS620ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS620ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS620ADWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS620ADWR	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI
SN74ALS620AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS620ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS621A-1DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621A-1DWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621A-1DWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621A-1DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621A-1DWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621A-1DWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621A-1N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS621A-1NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS621A-1NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621A-1NSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621A-1NSRG4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621ADWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621ADWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621ADWRG4	ACTIVE	SOIC	DW	20	2000	·	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS621AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS621ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type





.com 4-Jun-2007

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74ALS623A-1DW	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI
SN74ALS623A-1DWR	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI
SN74ALS623A-1N	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI
SN74ALS623ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS623ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS623ADWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS623ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS623ADWRE4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS623ADWRG4	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS623AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS623AN3	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI
SN74ALS623ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS623ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS623ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS623ANSRG4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74AS623DW	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI
SN74AS623DWR	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI
SN74AS623N	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is



PACKAGE OPTION ADDENDUM

4-Jun-2007

provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS621A-1DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.0	2.7	12.0	24.0	Q1
SN74ALS621ADWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.0	2.7	12.0	24.0	Q1
SN74ALS623ADWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.0	2.7	12.0	24.0	Q1





*All dimensions are nominal

7 III GITTIOTOTOTO GITO TTOTTIITIGI							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS621A-1DWR	SOIC	DW	20	2000	346.0	346.0	41.0
SN74ALS621ADWR	SOIC	DW	20	2000	346.0	346.0	41.0
SN74ALS623ADWR	SOIC	DW	20	2000	346.0	346.0	41.0

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DW (R-PDSO-G20)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products Amplifiers amplifier.ti.com Data Converters dataconverter.ti.com DSP dsp.ti.com Clocks and Timers www.ti.com/clocks Interface interface.ti.com Logic logic.ti.com Power Mgmt power.ti.com Microcontrollers microcontroller.ti.com www.ti-rfid.com RF/IF and ZigBee® Solutions www.ti.com/lprf

Applications	
Audio	www.ti.com/audio
Automotive	www.ti.com/automotive
Broadband	www.ti.com/broadband
Digital Control	www.ti.com/digitalcontrol
Medical	www.ti.com/medical
Military	www.ti.com/military
Optical Networking	www.ti.com/opticalnetwork
Security	www.ti.com/security
Telephony	www.ti.com/telephony
Video & Imaging	www.ti.com/video
Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2008, Texas Instruments Incorporated